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NL17SZ32E

Single 2-Input OR Gate

The NL17SZ32E is a single 2-input OR Gate in tiny footprint packages.

Features

- Designed for 1.65 V to 5.5 V V_{CC} Operation
- 2.4 ns t_{PD} at $V_{CC} = 5$ V (typ)
- Inputs/Outputs Overvoltage Tolerant up to 5.5 V
- I_{OFF} Supports Partial Power Down Protection
- Source/Sink 24 mA at 3.0 V
- Chip Complexity < 100 FETs
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

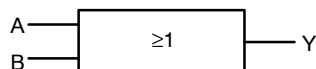


Figure 1. Logic Symbol



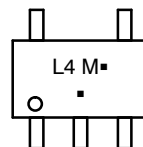
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MARKING DIAGRAM



SC-88A
DF SUFFIX
CASE 419A



L4 = Specific Device Code
M = Date Code*
■ = Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 7 of this data sheet.

NL17SZ32E

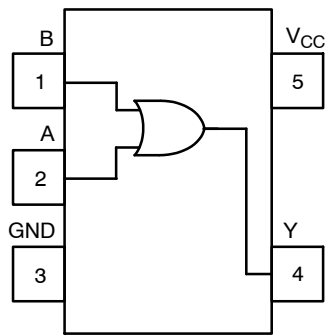


Figure 2. Pinout (Top View)

PIN ASSIGNMENT

Pin	Function
1	B
2	A
3	GND
4	Y
5	V _{CC}

FUNCTION TABLE

Input		Output Y = A + B
A	B	Y
L	L	L
L	H	H
H	L	H
H	H	H

MAXIMUM RATINGS

Symbol	Characteristics	Value	Unit
V_{CC}	DC Supply Voltage	-0.5 to +6.5	V
V_{IN}	DC Input Voltage	-0.5 to +6.5	V
V_{OUT}	DC Output Voltage Active-Mode (High or Low State) Tri-State Mode (Note 1) Power-Down Mode ($V_{CC} = 0$ V)	-0.5 to $V_{CC} + 0.5$ -0.5 to +6.5 -0.5 to +6.5	V
I_{IK}	DC Input Diode Current $V_{IN} < GND$	-50	mA
I_{OK}	DC Output Diode Current $V_{OUT} < GND$	-50	mA
I_{OUT}	DC Output Source/Sink Current	± 50	mA
I_{CC} or I_{GND}	DC Supply Current per Supply Pin or Ground Pin	± 100	mA
T_{STG}	Storage Temperature Range	-65 to +150	°C
T_L	Lead Temperature, 1 mm from Case for 10 secs	260	°C
T_J	Junction Temperature Under Bias	+150	°C
θ_{JA}	Thermal Resistance (Note 2)	659	°C/W
P_D	Power Dissipation in Still Air	190	mW
MSL	Moisture Sensitivity	Level 1	-
F_R	Flammability Rating Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-
V_{ESD}	ESD Withstand Voltage (Note 3) Human Body Model Charged Device Model	4000 1000	V
$I_{Latchup}$	Latchup Performance (Note 4)	± 100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Applicable to devices with outputs that may be tri-stated.
2. Measured with minimum pad spacing on an FR4 board, using 10mm-by-1inch, 2 ounce copper trace no air flow.
3. HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to EIA/JESD22-C101-F. JEDEC recommends that ESD qualification to EIA/JESD22-A115-A (Machine Model) be discontinued per JEDEC/JEP172A.
4. Tested to EIA/JESD78 Class II.

RECOMMENDED OPERATING CONDITIONS

Symbol	Characteristics		Min	Max	Unit
V _{CC}	Positive DC Supply Voltage		1.65	5.5	V
V _{IN}	DC Input Voltage		0	5.5	V
V _{OUT}	DC Output Voltage	Active-Mode (High or Low State)	0	V _{CC}	
		Tri-State Mode (Note 1)	0	5.5	
		Power-Down Mode (V _{CC} = 0 V)	0	5.5	
T _A	Operating Temperature Range		−55	+125	°C
t _r , t _f	Input Rise and Fall Time	V _{CC} = 1.65 V to 1.95 V	0	20	ns/V
		V _{CC} = 2.3 V to 2.7 V	0	20	
		V _{CC} = 3.0 V to 3.6 V	0	10	
		V _{CC} = 4.5 V to 5.5 V	0	5	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Condition	V_{CC} (V)	$T_A = 25^\circ\text{C}$			$-55^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$		Units
				Min	Typ	Max	Min	Max	
V_{IH}	High-Level Input Voltage		1.65 to 1.95	$0.65 V_{CC}$	–	–	$0.65 V_{CC}$	–	V
			2.3 to 5.5	$0.70 V_{CC}$	–	–	$0.70 V_{CC}$	–	
V_{IL}	Low-Level Input Voltage		1.65 to 1.95	–	–	$0.35 V_{CC}$	–	$0.35 V_{CC}$	V
			2.3 to 5.5	–	–	$0.30 V_{CC}$	–	$0.30 V_{CC}$	
V_{OH}	High-Level Output Voltage	$V_{IN} = V_{IH}$ or V_{IL}	1.65 to 5.5	$V_{CC} - 0.1$	V_{CC}	–	$V_{CC} - 0.1$	–	V
		$I_{OH} = -100 \mu\text{A}$	1.65	1.29	1.4	–	1.29	–	
		$I_{OH} = -4 \text{ mA}$	2.3	1.9	–	–	1.9	–	
		$I_{OH} = -8 \text{ mA}$	2.7	2.2	2.1	–	2.2	–	
		$I_{OH} = -12 \text{ mA}$	3.0	2.4	2.4	–	2.4	–	
		$I_{OH} = -16 \text{ mA}$	3.0	2.4	2.7	–	2.4	–	
		$I_{OH} = -24 \text{ mA}$	3.0	2.3	2.5	–	2.3	–	
		$I_{OH} = -32 \text{ mA}$	4.5	3.8	4.0	–	3.8	–	
V_{OL}	Low-Level Output Voltage	$V_{IN} = V_{IH}$ or V_{IL}	1.65 to 5.5	–	–	0.1	–	0.1	V
		$I_{OL} = 100 \mu\text{A}$	1.65	–	0.08	0.24	–	0.24	
		$I_{OL} = 4 \text{ mA}$	2.3	–	0.2	0.3	–	0.3	
		$I_{OL} = 8 \text{ mA}$	2.7	–	0.22	0.4	–	0.4	
		$I_{OL} = 12 \text{ mA}$	3.0	–	0.28	0.4	–	0.4	
		$I_{OL} = 16 \text{ mA}$	3.0	–	0.38	0.55	–	0.55	
		$I_{OL} = 24 \text{ mA}$	3.0	–	0.38	0.55	–	0.55	
		$I_{OL} = 32 \text{ mA}$	4.5	–	0.42	0.55	–	0.55	
I_{IN}	Input Leakage Current	$V_{IN} = 5.5 \text{ V}$ or GND	1.65 to 5.5	–	–	$\pm 0.1^*$	–	± 1.0	μA
I_{OFF}	Power Off Leakage Current	$V_{IN} = 5.5 \text{ V}$ or $V_{OUT} = 5.5 \text{ V}$	0	–	–	1.0	–	10	μA
I_{CC}	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	5.5	–	–	1.0	–	10	μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

*Guaranteed by design.

NL17SZ32E

AC ELECTRICAL CHARACTERISTICS ($t_R = t_F = 3.0 \text{ ns}$)

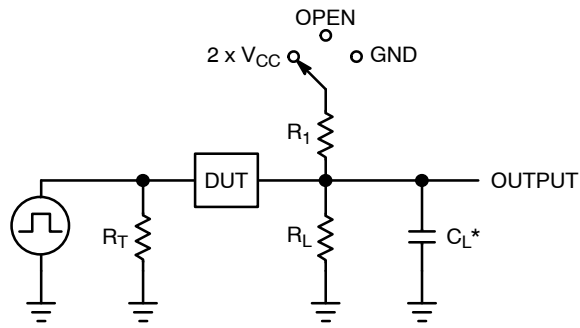
Symbol	Parameter	Condition	V_{CC} (V)	$T_A = 25^\circ\text{C}$			$-55^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$		Units
				Min	Typ	Max	Min	Max	
t_{PLH} t_{PHL}	Propagation Delay, A to Y (Figures 3 and 4)	$R_L = 1 \text{ M}\Omega$, $C_L = 15 \text{ pF}$	1.65 to 1.95	–	5.5	12	–	12.7	ns
		$R_L = 1 \text{ M}\Omega$, $C_L = 15 \text{ pF}$	2.3 to 2.7	–	3.0	7.0	–	7.5	
		$R_L = 1 \text{ M}\Omega$, $C_L = 15 \text{ pF}$	3.0 to 3.6	–	2.6	4.7	–	5.0	
		$R_L = 500 \text{ }\Omega$, $C_L = 50 \text{ pF}$		–	3.0	5.2	–	5.5	
		$R_L = 1 \text{ M}\Omega$, $C_L = 15 \text{ pF}$	4.5 to 5.5	–	2.2	4.1	–	4.4	
		$R_L = 500 \text{ }\Omega$, $C_L = 50 \text{ pF}$		–	2.4	4.5	–	4.8	

CAPACITIVE CHARACTERISTICS ($t_R = t_F = 3.0 \text{ ns}$)

Symbol	Parameter	Condition	Typical	Units
C_{IN}	Input Capacitance	$V_{CC} = 5.5 \text{ V}$, $V_{IN} = 0 \text{ V}$ or V_{CC}	2.5	pF
C_{OUT}	Output Capacitance	$V_{CC} = 5.5 \text{ V}$, $V_{IN} = 0 \text{ V}$ or V_{CC}	2.5	pF
C_{PD}	Power Dissipation Capacitance (Note 5)	10 MHz, $V_{CC} = 3.3 \text{ V}$, $V_{IN} = 0 \text{ V}$ or V_{CC} 10 MHz, $V_{CC} = 5.5 \text{ V}$, $V_{IN} = 0 \text{ V}$ or V_{CC}	9 11	pF

5. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: $I_{CC(OPR)} = C_{PD} \cdot V_{CC} \cdot f_{in} + I_{CC}$. C_{PD} is used to determine the no-load dynamic power consumption; $P_D = C_{PD} \cdot V_{CC}^2 \cdot f_{in} + I_{CC} \cdot V_{CC}$.

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C_L includes probe and jig capacitance
 R_T is Z_{OUT} of pulse generator (typically 50 Ω)
 $f = 1$ MHz

Figure 3. Test Circuit

Test	Switch Position	C_L , pF	R_L , Ω	R_1 , Ω
t_{PLH} / t_{PHL}	Open	See AC Characteristics Table		
t_{PLZ} / t_{PZL}	$2 \times V_{CC}$	50	500	500
t_{PHZ} / t_{PZH}	GND	50	500	500

X = Don't Care

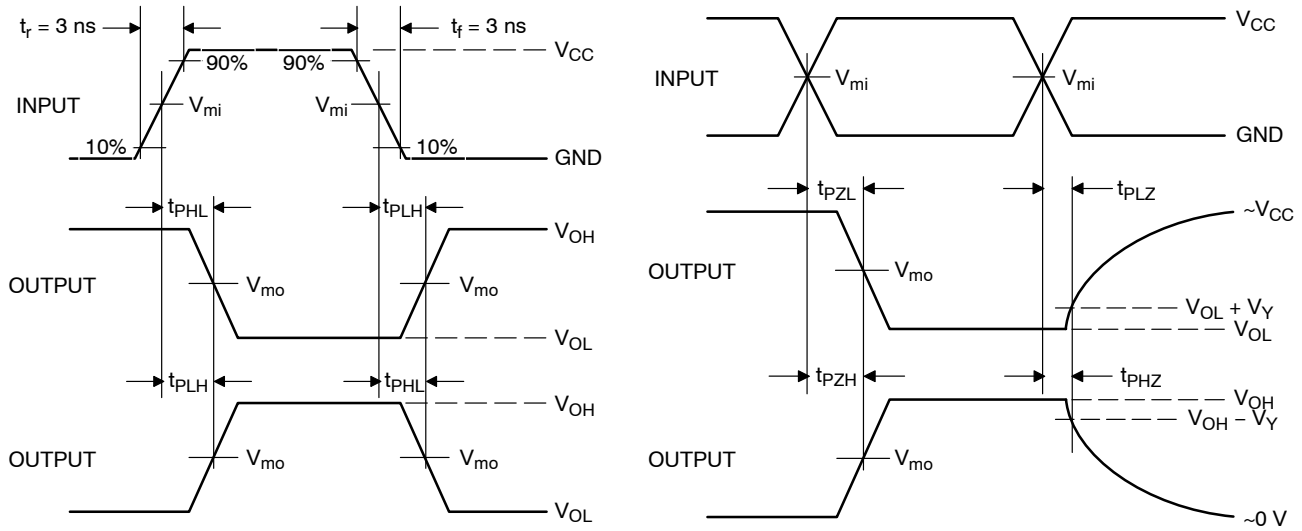


Figure 4. Switching Waveforms

V_{CC} , V	V_{mi} , V	V_{mo} , V		V_Y , V
		t_{PLH}, t_{PHL}	$t_{PZL}, t_{PLZ}, t_{PZH}, t_{PHZ}$	
1.65 to 1.95	$V_{CC}/2$	$(V_{OH} - V_{OL})/2$	$V_{CC}/2$	0.15
2.3 to 2.7	$V_{CC}/2$	$(V_{OH} - V_{OL})/2$	$V_{CC}/2$	0.15
3.0 to 3.6	$V_{CC}/2$	$(V_{OH} - V_{OL})/2$	$V_{CC}/2$	0.3
4.5 to 5.5	$V_{CC}/2$	$(V_{OH} - V_{OL})/2$	$V_{CC}/2$	0.3

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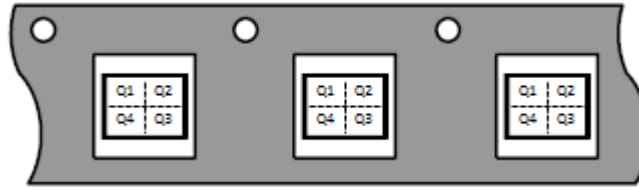
DEVICE ORDERING INFORMATION

Device	Packages	Specific Device Code	Pin 1 Orientation (See below)	Shipping [†]
NL17SZ32EDFT2G	SC-88A	L4	Q4	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

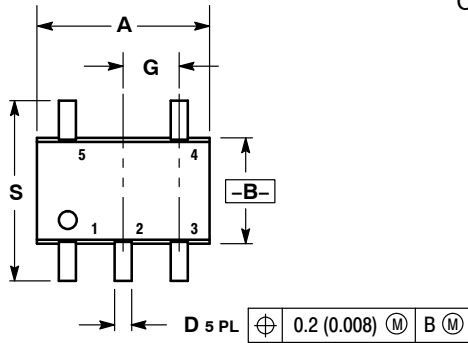
Pin 1 Orientation in Tape and Reel

Direction of Feed



PACKAGE DIMENSIONS

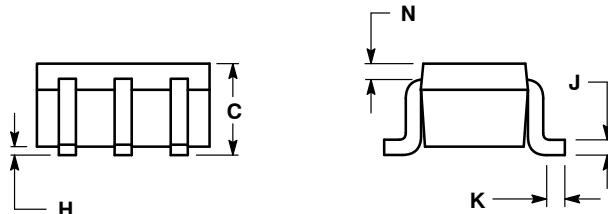
SC-88A (SC-70-5/SOT-353)
CASE 419A-02
ISSUE L



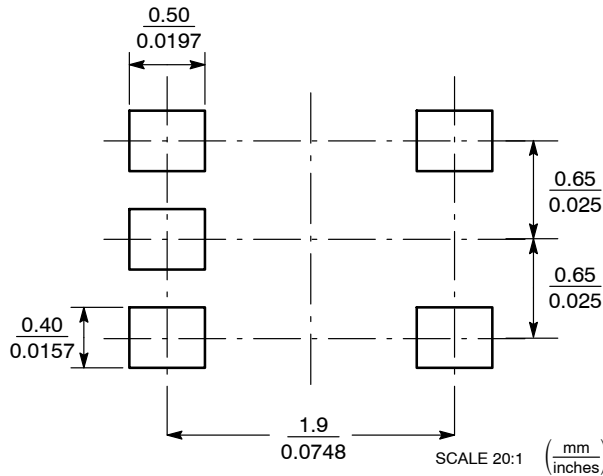
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 419A-01 OBSOLETE. NEW STANDARD 419A-02.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.071	0.087	1.80	2.20
B	0.045	0.053	1.15	1.35
C	0.031	0.043	0.80	1.10
D	0.004	0.012	0.10	0.30
G	0.026 BSC		0.65 BSC	
H	---	0.004	---	0.10
J	0.004	0.010	0.10	0.25
K	0.004	0.012	0.10	0.30
N	0.008 REF		0.20 REF	
S	0.079	0.087	2.00	2.20



SOLDER FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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